



# PMEG60T30ELR

60 V, 3 A low leakage current Trench MEGA Schottky barrier rectifier

1 April 2023

Product data sheet

## 1. General description

Trench Maximum Efficiency General Application (MEGA) Schottky barrier rectifier encapsulated in a CFP3 (SOD123W) small and flat lead Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- Average forward current:  $I_{F(AV)} \leq 3$  A
- Reverse voltage:  $V_R \leq 60$  V
- Low forward voltage
- Low leakage current due to Trench MEGA Schottky technology
- High power capability due to clip-bonding technology
- Small and flat lead SMD power plastic package
- Suitable for both reflow and wave soldering

## 3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Freewheeling application
- Reverse polarity protection
- Low power consumption application

## 4. Quick reference data



Table 1. Quick reference data

| Symbol      | Parameter               | Conditions   |     | Min | Typ  | Max | Unit    |
|-------------|-------------------------|--|-----|-----|------|-----|---------|
| $I_{F(AV)}$ | average forward current | $\delta = 0.5$ ; $f = 20$ kHz; square wave; $T_{sp} \leq 147$ °C |     | -   | -    | 3   | A       |
| $V_R$       | reverse voltage         | $T_j = 25$ °C  |     | -   | -    | 60  | V       |
| $V_F$       | forward voltage         | $I_F = 3$ A; pulsed; $T_j = 25$ °C                               | [1] | -   | 550  | 620 | mV      |
| $I_R$       | reverse current         | $V_R = 10$ V; pulsed; $T_j = 25$ °C                              | [1] | -   | 0.14 | 0.9 | $\mu$ A |
|             |                         | $V_R = 60$ V; pulsed; $T_j = 25$ °C                              | [1] | -   | 0.3  | 1.8 | $\mu$ A |

[1] Very short pulse, in order to maintain a stable junction temperature.

## 5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline  | Graphic symbol  |
|-----|--------|-------------|---|---|
| 1   | K      | cathode     | <br>CFP3 (SOD123W) | <br>sym001 |
| 2   | A      | anode       |   |   |

## 6. Ordering information

Table 3. Ordering information

| Type number                  | Package |  |                         |
|------------------------------|---------|--|-------------------------|
|                              | Name    | Description  | Version                 |
| <a href="#">PMEG60T30ELR</a> | CFP3    | plastic, surface mounted package; 2 terminals; 2.6 mm x 1.7 mm x 1 mm body | <a href="#">SOD123W</a> |

## 7. Marking

Table 4. Marking codes

| Type number  | Marking code |
|--------------|--------------|
| PMEG60T30ELR | L8           |

## 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol      | Parameter                           | Conditions   |     | Min | Max  | Unit |
|-------------|-------------------------------------|--|-----|-----|------|------|
| $V_R$       | reverse voltage                     | $T_j = 25\text{ °C}$   |     | -   | 60   | V    |
| $I_F$       | forward current                     | $\delta = 1; T_{sp} \leq 140\text{ °C}$                                      |     | -   | 4.2  | A    |
| $I_{F(AV)}$ | average forward current             | $\delta = 0.5; f = 20\text{ kHz}$ ; square wave; $T_{sp} \leq 147\text{ °C}$ |     | -   | 3    | A    |
| $I_{FSM}$   | non-repetitive peak forward current | $t_p = 8\text{ ms}$ ; square wave; $T_{j(\text{init})} = 25\text{ °C}$       |     | -   | 60   | A    |
| $P_{tot}$   | total power dissipation             | $T_{amb} \leq 25\text{ °C}$  | [1] | -   | 0.68 | W    |
|             |                                     |  | [2] | -   | 1.15 | W    |
| $T_j$       | junction temperature                |  |     | -   | 175  | °C   |
| $T_{amb}$   | ambient temperature                 |  |     | -55 | 175  | °C   |
| $T_{stg}$   | storage temperature                 |  |     | -65 | 175  | °C   |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode  $1\text{ cm}^2$ .

## 9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol         | Parameter  | Conditions  |         | Min | Typ | Max | Unit |
|----------------|--|-------------|---------|-----|-----|-----|------|
| $R_{th(j-a)}$  | thermal resistance from junction to ambient      | in free air | [1] [2] | -   | -   | 220 | K/W  |
|                |  |             | [1] [3] | -   | -   | 130 | K/W  |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point |             | [4]     | -   | -   | 18  | K/W  |

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses  $P_R$  are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Soldering point of cathode tab.

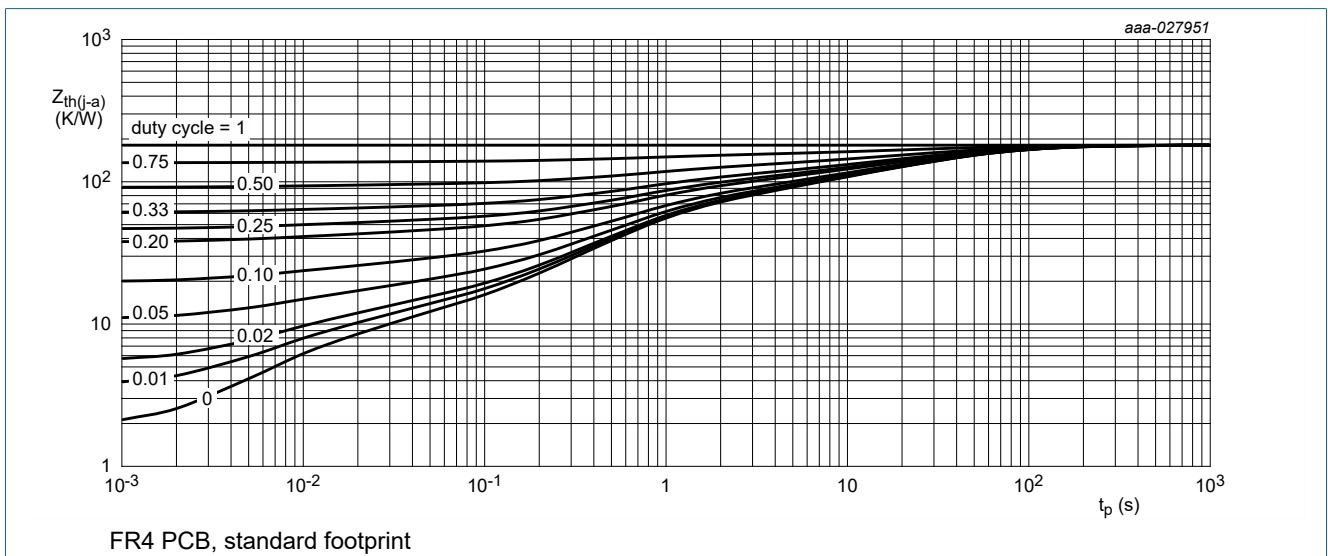


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

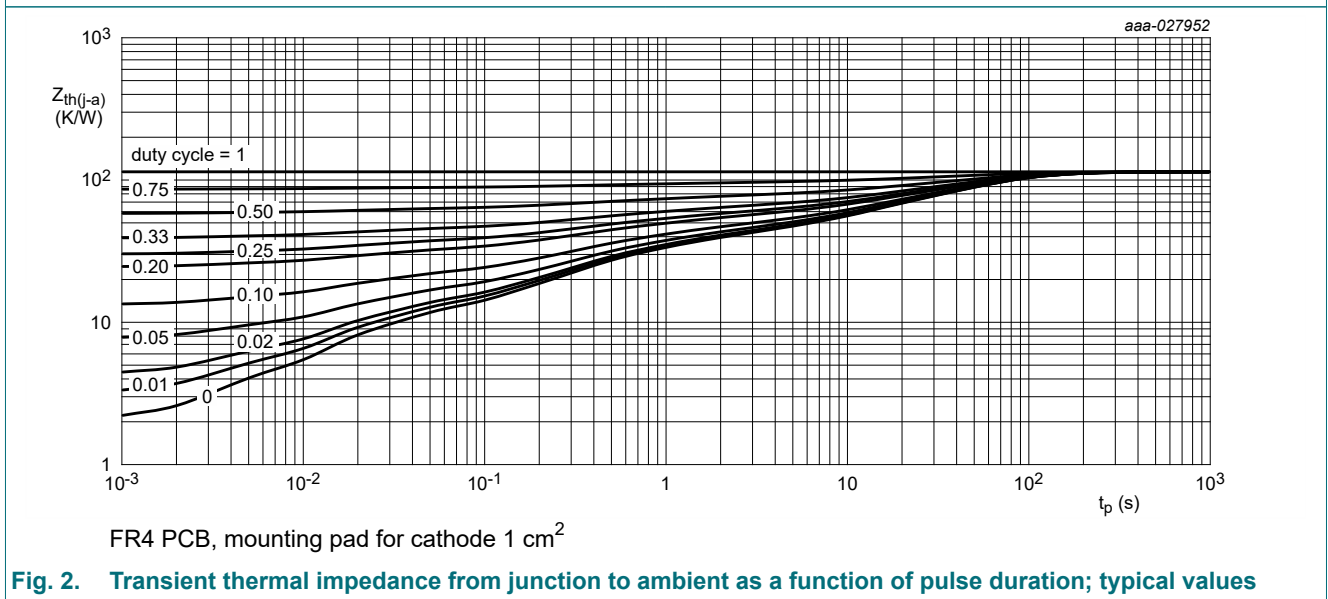


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

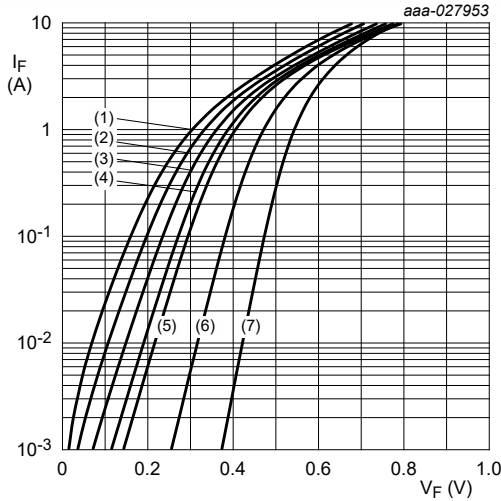
## 10. Characteristics

Table 7. Characteristics

| Symbol      | Parameter                           | Conditions   |     | Min | Typ  | Max | Unit          |
|-------------|-------------------------------------|--|-----|-----|------|-----|---------------|
| $V_{(BR)R}$ | reverse breakdown voltage           | $I_R = 1 \text{ mA}$ ; pulsed; $T_j = 25 \text{ }^\circ\text{C}$   | [1] | 60  | -    | -   | V             |
| $V_F$       | forward voltage                     | $I_F = 0.1 \text{ A}$ ; pulsed; $T_j = 25 \text{ }^\circ\text{C}$  | [1] | -   | 380  | 450 | mV            |
|             |                                     | $I_F = 0.5 \text{ A}$ ; pulsed; $T_j = 25 \text{ }^\circ\text{C}$  | [1] | -   | 440  | 510 | mV            |
|             |                                     | $I_F = 1 \text{ A}$ ; pulsed; $T_j = 25 \text{ }^\circ\text{C}$  | [1] | -   | 470  | 540 | mV            |
|             |                                     | $I_F = 2 \text{ A}$ ; pulsed; $T_j = 25 \text{ }^\circ\text{C}$  | [1] | -   | 515  | 590 | mV            |
|             |                                     | $I_F = 3 \text{ A}$ ; pulsed; $T_j = 25 \text{ }^\circ\text{C}$  | [1] | -   | 550  | 620 | mV            |
|             |                                     | $I_F = 3 \text{ A}$ ; pulsed; $T_j = -40 \text{ }^\circ\text{C}$   | [1] | -   | 610  | -   | mV            |
|             |                                     | $I_F = 3 \text{ A}$ ; pulsed; $T_j = 125 \text{ }^\circ\text{C}$   | [1] | -   | 480  | -   | mV            |
| $I_R$       | reverse current                     | $V_R = 10 \text{ V}$ ; pulsed; $T_j = 25 \text{ }^\circ\text{C}$   | [1] | -   | 0.14 | 0.9 | $\mu\text{A}$ |
|             |                                     | $V_R = 40 \text{ V}$ ; pulsed; $T_j = 25 \text{ }^\circ\text{C}$   | [1] | -   | 0.18 | -   | $\mu\text{A}$ |
|             |                                     | $V_R = 60 \text{ V}$ ; pulsed; $T_j = 25 \text{ }^\circ\text{C}$   | [1] | -   | 0.3  | 1.8 | $\mu\text{A}$ |
|             |                                     | $V_R = 60 \text{ V}$ ; pulsed; $T_j = 125 \text{ }^\circ\text{C}$  | [1] | -   | 0.5  | -   | mA            |
| $C_d$       | diode capacitance                   | $V_R = 1 \text{ V}$ ; $f = 1 \text{ MHz}$ ; $T_j = 25 \text{ }^\circ\text{C}$  |     | -   | 580  | -   | pF            |
|             |                                     | $V_R = 10 \text{ V}$ ; $f = 1 \text{ MHz}$ ; $T_j = 25 \text{ }^\circ\text{C}$   |     | -   | 180  | -   | pF            |
| $t_{rr}$    | reverse recovery time step recovery | $I_F = 0.5 \text{ A}$ ; $I_R = 0.5 \text{ A}$ ; $I_{R(\text{meas})} = 0.1 \text{ A}$ ; $T_j = 25 \text{ }^\circ\text{C}$ |     | -   | 17   | -   | ns            |
|             | reverse recovery time ramp recovery | $dI_F/dt = 200 \text{ A}/\mu\text{s}$ ; $I_F = 6 \text{ A}$ ; $V_R = 26 \text{ V}$ ; $T_j = 25 \text{ }^\circ\text{C}$   |     | -   | 16   | -   | ns            |
| $V_{FRM}$   | peak forward recovery voltage       | $I_F = 0.5 \text{ A}$ ; $dI_F/dt = 20 \text{ A}/\mu\text{s}$ ; $T_j = 25 \text{ }^\circ\text{C}$                         |     | -   | 460  | -   | mV            |

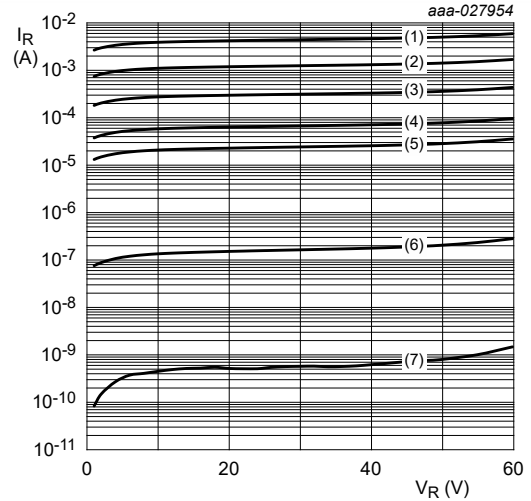
[1] Very short pulse, in order to maintain a stable junction temperature.

60 V, 3 A low leakage current Trench MEGA Schottky barrier rectifier



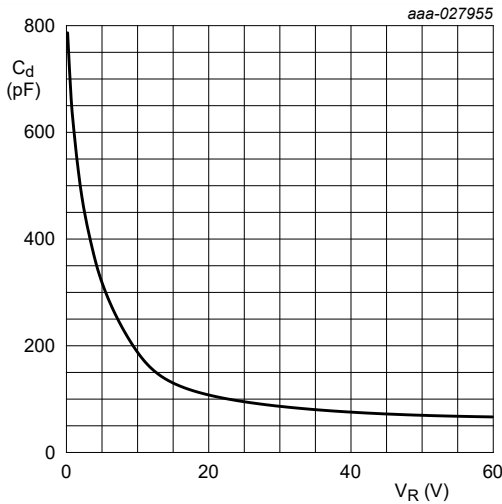
pulsed condition  
 (1)  $T_j = 175\text{ }^\circ\text{C}$   
 (2)  $T_j = 150\text{ }^\circ\text{C}$   
 (3)  $T_j = 125\text{ }^\circ\text{C}$   
 (4)  $T_j = 100\text{ }^\circ\text{C}$   
 (5)  $T_j = 85\text{ }^\circ\text{C}$   
 (6)  $T_j = 25\text{ }^\circ\text{C}$   
 (7)  $T_j = -40\text{ }^\circ\text{C}$

Fig. 3. Forward current as a function of forward voltage; typical values



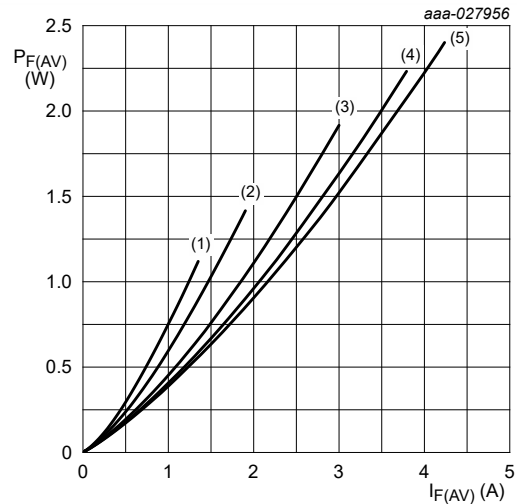
pulsed condition  
 (1)  $T_j = 175\text{ }^\circ\text{C}$   
 (2)  $T_j = 150\text{ }^\circ\text{C}$   
 (3)  $T_j = 125\text{ }^\circ\text{C}$   
 (4)  $T_j = 100\text{ }^\circ\text{C}$   
 (5)  $T_j = 85\text{ }^\circ\text{C}$   
 (6)  $T_j = 25\text{ }^\circ\text{C}$   
 (7)  $T_j = -40\text{ }^\circ\text{C}$

Fig. 4. Reverse current as a function of reverse voltage; typical values



$f = 1\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$

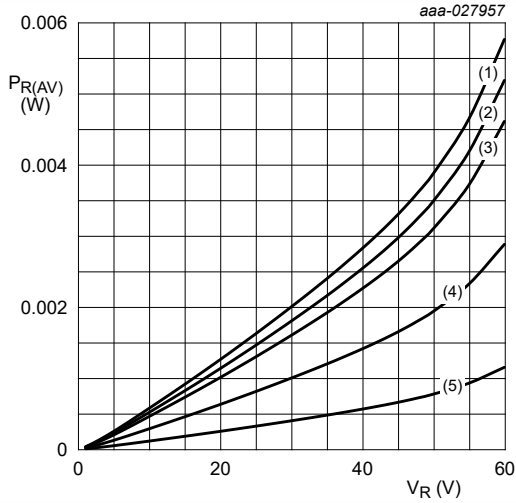
Fig. 5. Diode capacitance as a function of reverse voltage; typical values



$T_j = 100\text{ }^\circ\text{C}$   
 (1)  $\delta = 0.1$   
 (2)  $\delta = 0.2$   
 (3)  $\delta = 0.5$   
 (4)  $\delta = 0.8$   
 (5)  $\delta = 1$ ; DC

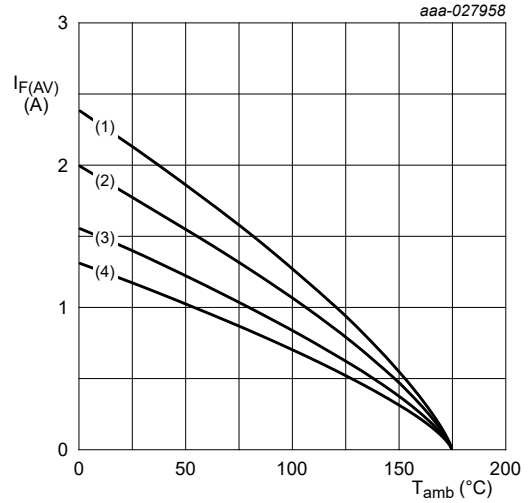
Fig. 6. Average forward power dissipation as a function of average forward current; typical values

60 V, 3 A low leakage current Trench MEGA Schottky barrier rectifier



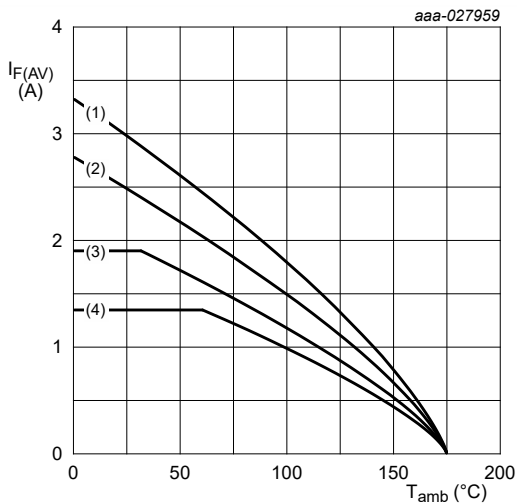
$T_j = 100\text{ }^\circ\text{C}$   
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.9$   
 (3)  $\delta = 0.8$   
 (4)  $\delta = 0.5$   
 (5)  $\delta = 0.2$

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



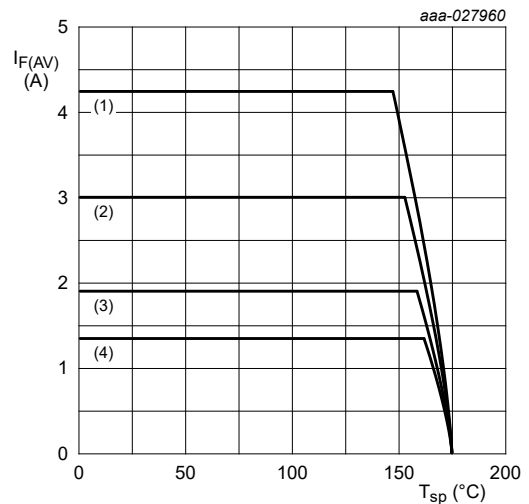
FR4 PCB, standard footprint  
 $T_j = 175\text{ }^\circ\text{C}$   
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.5$ ;  $f = 20\text{ kHz}$   
 (3)  $\delta = 0.2$ ;  $f = 20\text{ kHz}$   
 (4)  $\delta = 0.1$ ;  $f = 20\text{ kHz}$

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode  $1\text{ cm}^2$   
 $T_j = 175\text{ }^\circ\text{C}$   
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.5$ ;  $f = 20\text{ kHz}$   
 (3)  $\delta = 0.2$ ;  $f = 20\text{ kHz}$   
 (4)  $\delta = 0.1$ ;  $f = 20\text{ kHz}$

Fig. 9. Average forward current as a function of ambient temperature; typical values



$T_j = 175\text{ }^\circ\text{C}$   
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.5$ ;  $f = 20\text{ kHz}$   
 (3)  $\delta = 0.2$ ;  $f = 20\text{ kHz}$   
 (4)  $\delta = 0.1$ ;  $f = 20\text{ kHz}$

Fig. 10. Average forward current as a function of solder point temperature; typical values

### 11. Test information

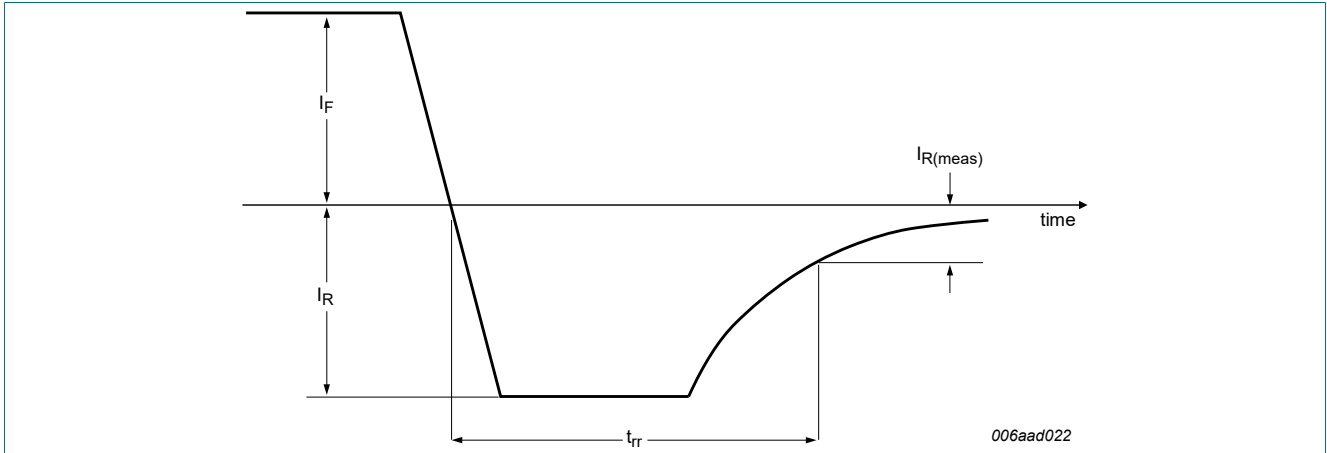


Fig. 11. Reverse recovery definition; step recovery

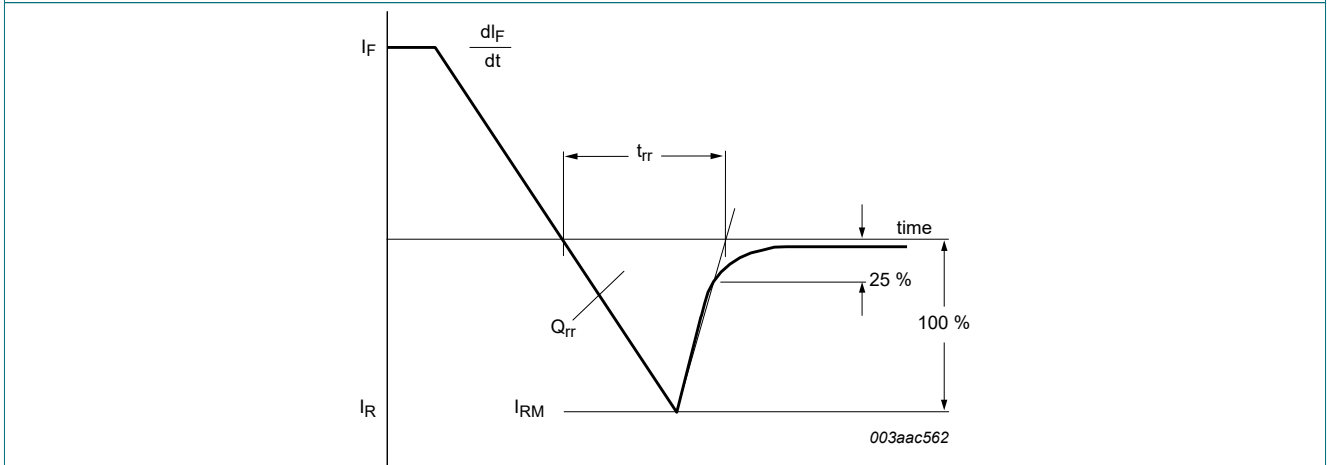


Fig. 12. Reverse recovery definition; ramp recovery

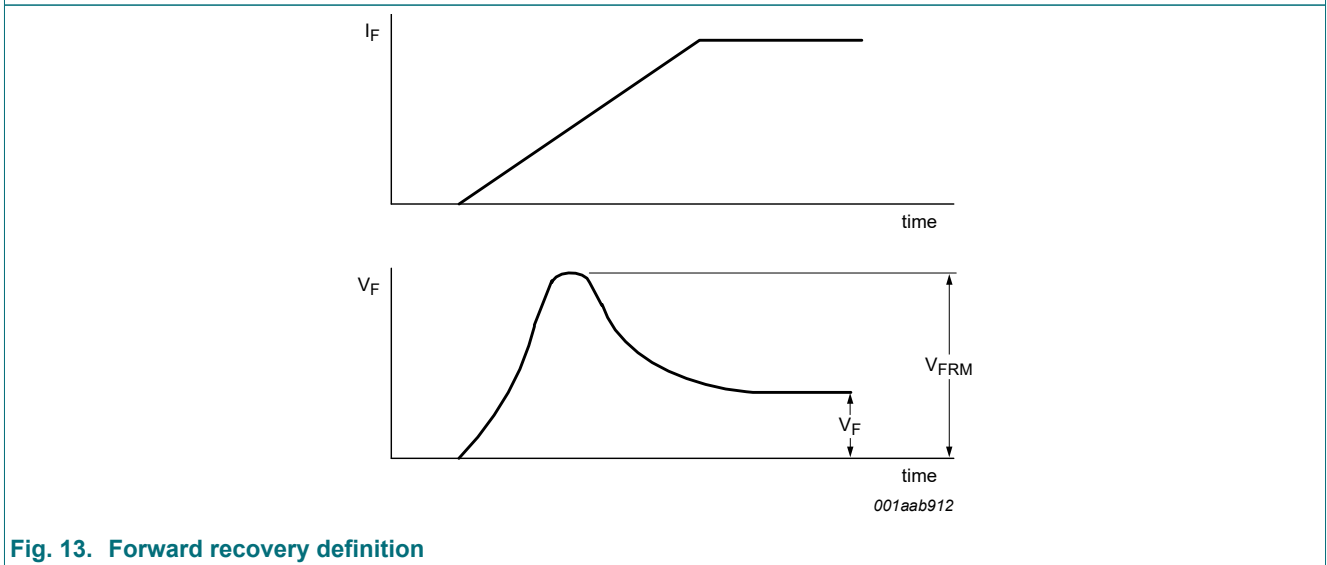


Fig. 13. Forward recovery definition

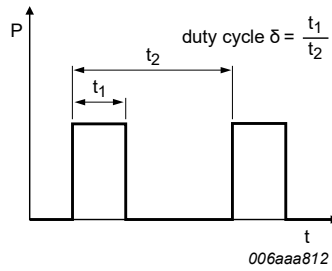


Fig. 14. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:

$$I_{F(AV)} = I_M \times \delta$$

with  $I_M$  defined as peak current

$$I_{RMS} = I_{F(AV)} \text{ at DC, and } I_{RMS} = I_M \times \sqrt{\delta}$$

with  $I_{RMS}$  defined as RMS current.

## 12. Package outline

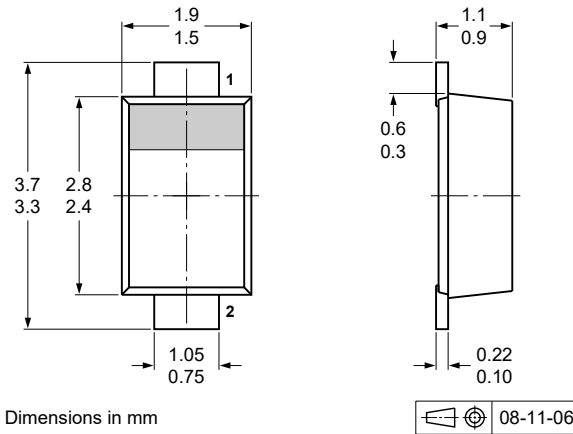
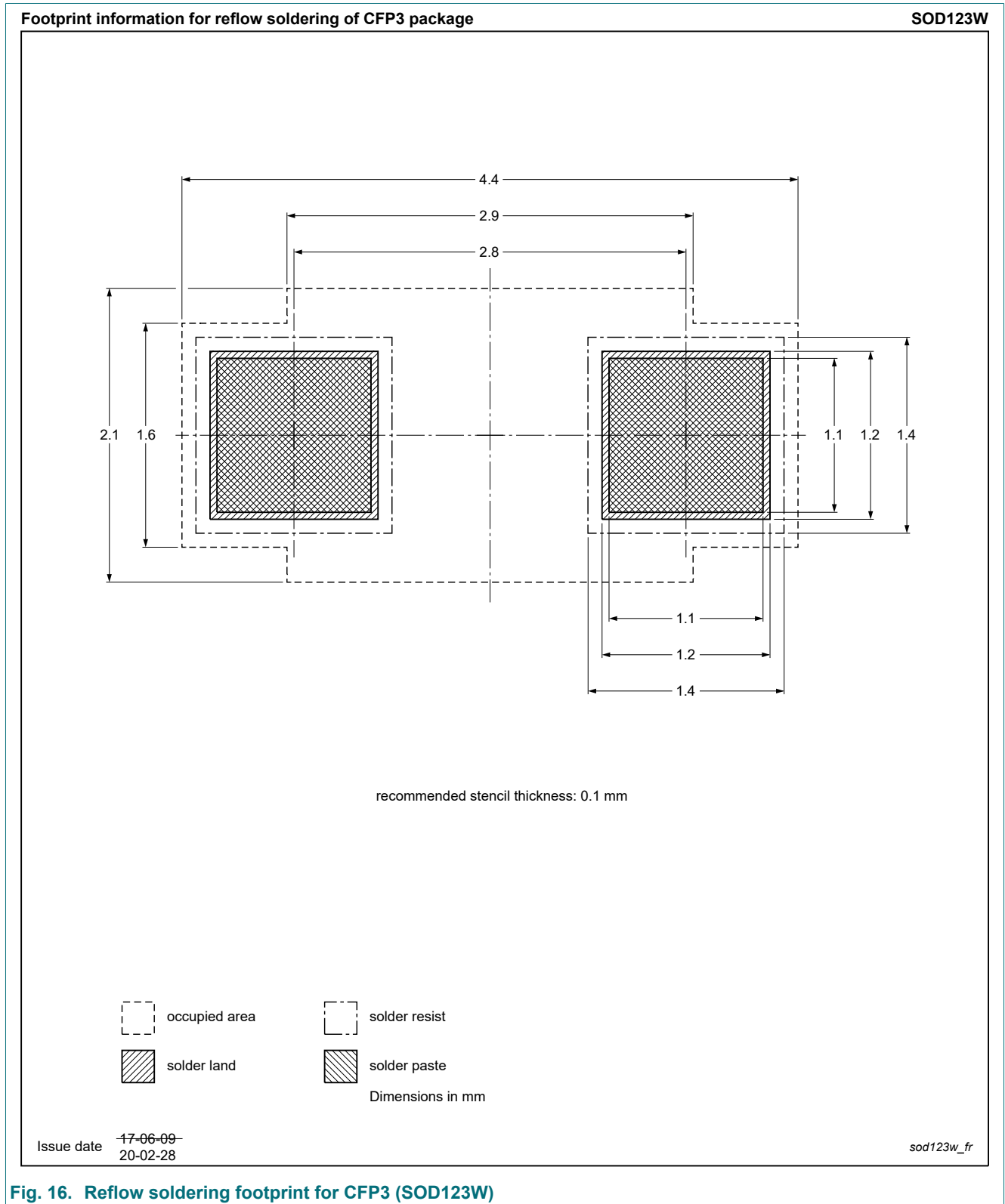


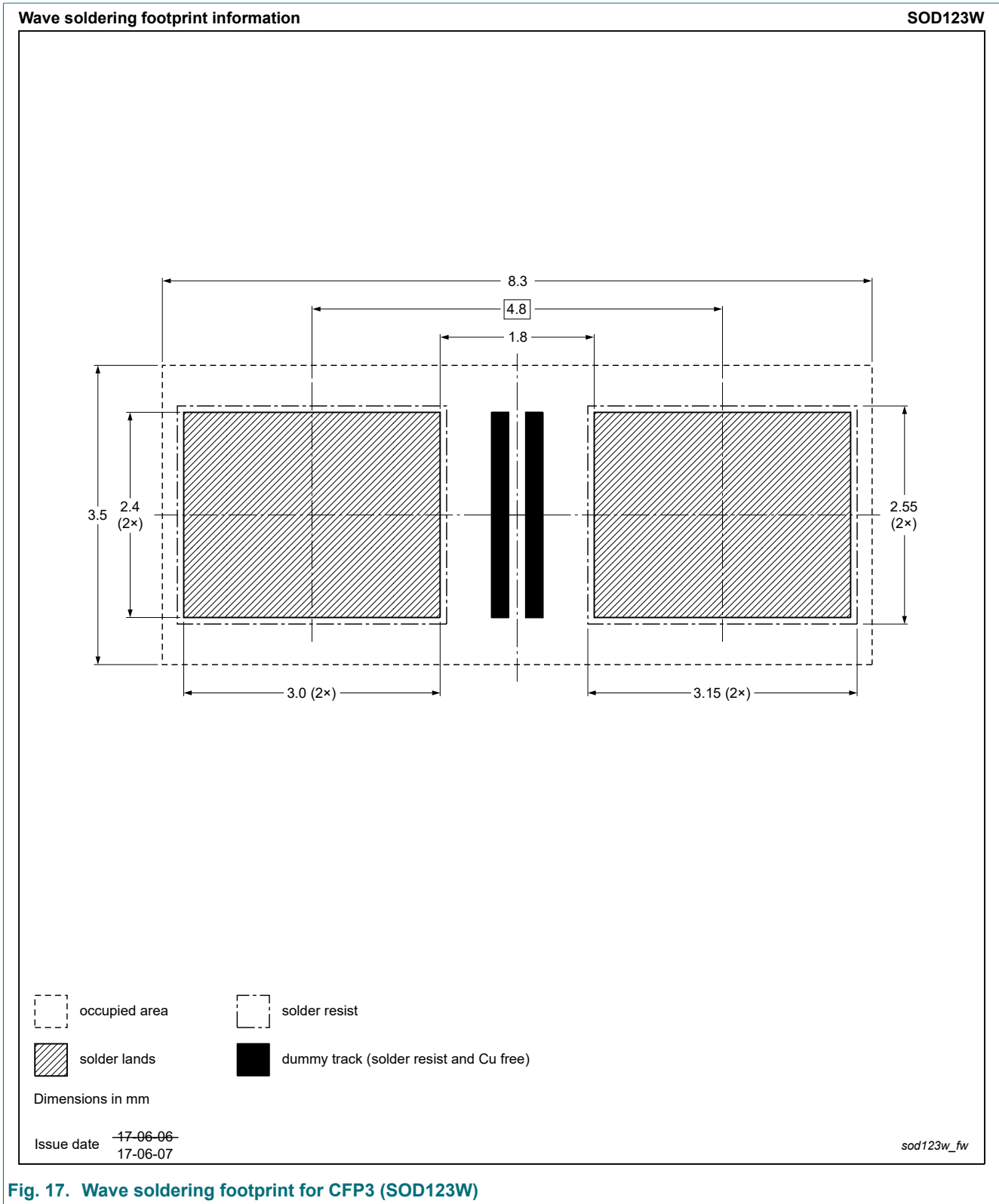
Fig. 15. Package outline CFP3 (SOD123W)



### 13. Soldering



**Fig. 16. Reflow soldering footprint for CFP3 (SOD123W)**



**Fig. 17. Wave soldering footprint for CFP3 (SOD123W)**

## 14. Revision history

Table 8. Revision history

| Data sheet ID    | Release date  | Data sheet status      | Change notice | Supersedes       |
|------------------|---|------------------------|---------------|------------------|
| PMEG60T30ELR v.3 | 20230401  | Product data sheet     | -             | PMEG60T30ELR v.2 |
| Modifications:   | • Product changed to non automotive. Please refer to the automotive product(s) with -Q. |                        |               |                  |
| PMEG60T30ELR v.2 | 20180524  | Product data sheet     | -             | PMEG60T30ELR v.1 |
| PMEG60T30ELR v.1 | 20180227  | Preliminary data sheet | -             | -                |

## 15. Legal information

### Data sheet status

| Document status [1][2]         | Product status [3] | Definition  |
|--------------------------------|--------------------|---|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification      | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production         | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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